NIKO-SEM

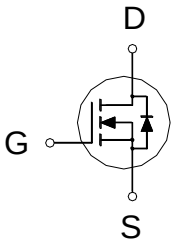
N-Channel High Voltage Mode
Field Effect Transistor

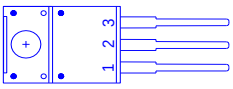
P0770VTF
TO-220F

Halogen-Free & Lead-Free

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
700V	650mΩ	7A





1. GATE
2. DRAIN
3. SOURCE

ABSOLUTE MAXIMUN RATINGS(T_A=25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	700	V
Gate-Source Voltage		V_{GS}	±30	V
Continuous Drain Current[2]	T_C = 25 °C	I_D	7	A
	T_C = 100 °C		4.4	
Pulsed Drain Current[1]		I_{DM}	17	
Avalanche Current[3]		I_{AS}	2.6	A
Avalanche Energy[3]		E_{AS}	135	mJ
Power Dissipation	T_C = 25 °C	P_D	30	W
	T_C = 100 °C		12	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		4.1	°C / W
Junction-to-Ambient	$R_{\theta JA}$		62.5	°C / W

[1]Pulse width limited by maximum junction temperature.
[2]Ensure that the channel temperature does not exceed 150°C.
[3]V_{DD} = 50V , L = 40mH ,starting T_J = 25°C.

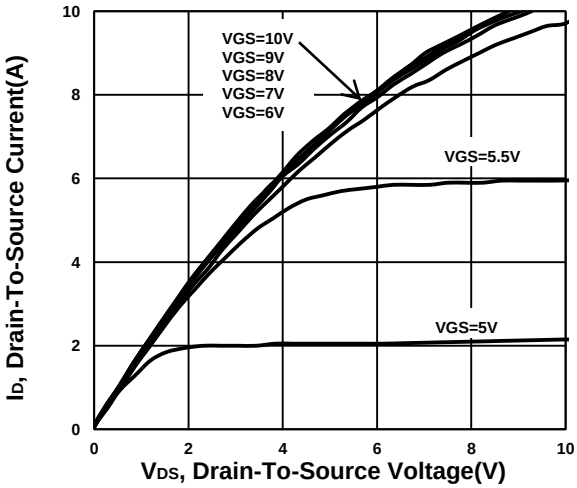
ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	700			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	2	3.5	4	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±30V			±100	nA
Gate Voltage Drain Current	I_{DSS}	V_{DS} = 700V, V_{GS} = 0V , T_C = 25 °C			1	μA
		V_{DS} = 560V, V_{GS} = 0V , T_C = 100 °C			100	

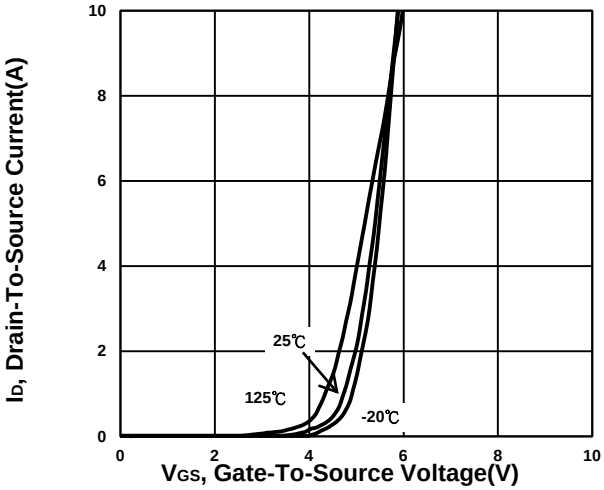
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 10V, I_D = 3.5A		502	650	mΩ
Forward Transconductance[1]	g_{fs}	V_{DS} = 10V, I_D = 3.5A		6.5		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 100V, f = 250KHz		649		pF
Output Capacitance	C_{oss}			40		
Reverse Transfer Capacitance	C_{rss}			6.4		
Effective Output Capacitance[4]	$C_{o(er)}$	V_{GS} = 0V, V_{DS} = 0 to 560V		30		
Total Gate Charge[2]	Q_g	V_{DD} = 560V, I_D =3.5A, V_{GS} = 10V		17		nC
Gate-Source Charge[2]	Q_{gs}			3.6		
Gate-Drain Charge[2]	Q_{gd}			6.7		
Turn-On Delay Time[2]	$t_{d(on)}$	V_{DD} = 350V, I_D =3.5A, R_G= 10Ω		18		nS
Rise Time[2]	t_r			19		
Turn-Off Delay Time[2]	$t_{d(off)}$			66		
Fall Time[2]	t_f			18		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current[3]	I_S				7	A
Forward Voltage[1]	V_{SD}	I_F =7A, V_{GS} = 0V			1	V
Reverse Recovery Time	t_{rr}	I_F =3.5A, dI_F/dt = 100A / μS		235		nS
Reverse Recovery Charge	Q_{rr}			2.3		uC

[1]Pulse test : Pulse Width ≤ 380 μsec, Duty Cycle ≤ 2%.
[2]Independent of operating temperature.
[3]Pulse width limited by maximum junction temperature.
[4]$C_{o(er)}$ is a fixed capacitance that gives the same stored energy as Coss while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$.

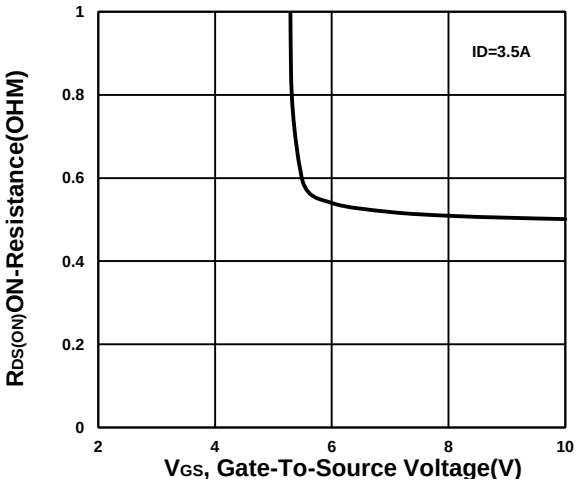
Output Characteristics



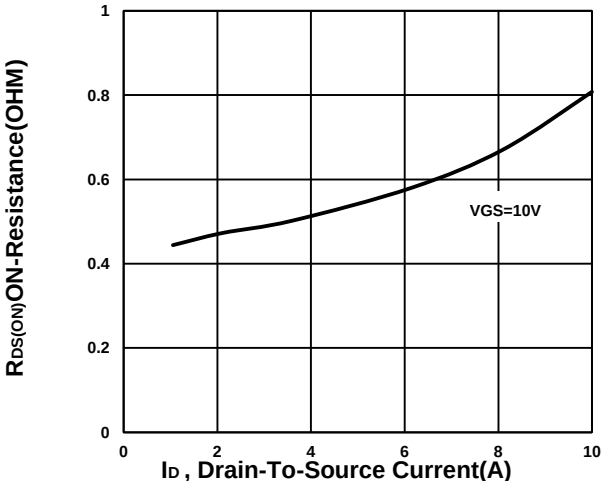
Transfer Characteristics



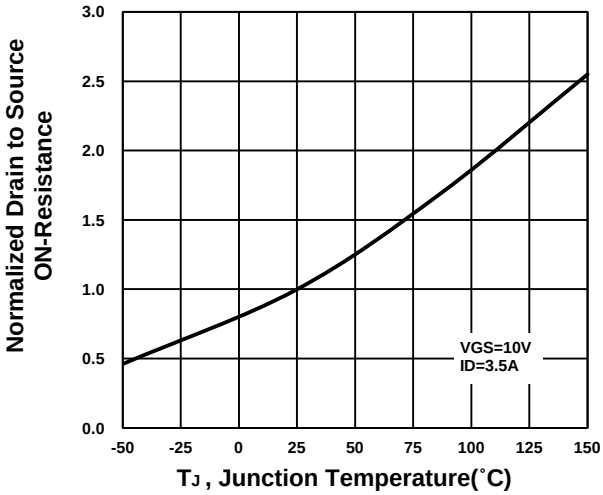
On-Resistance VS Gate-To-Source Voltage



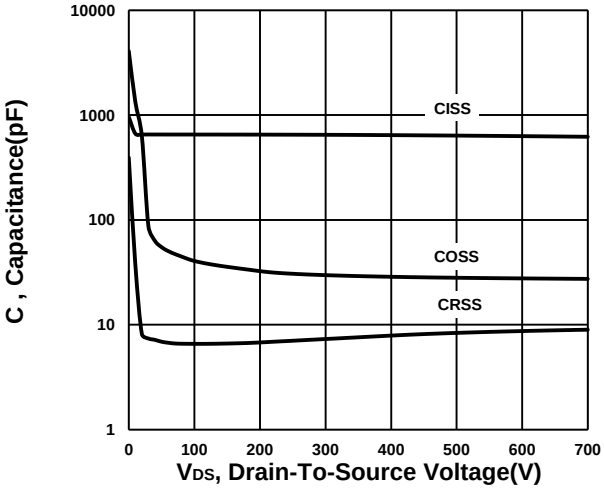
On-Resistance VS Drain Current



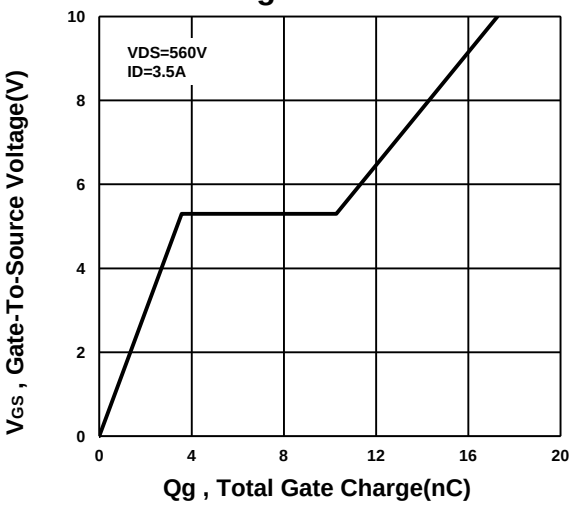
On-Resistance VS Temperature



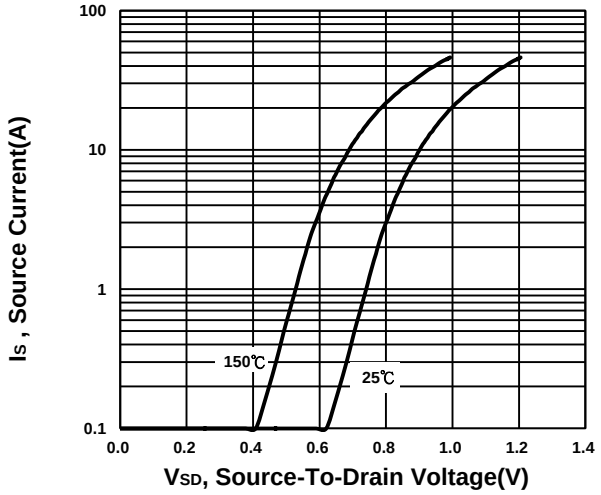
Capacitance Characteristic



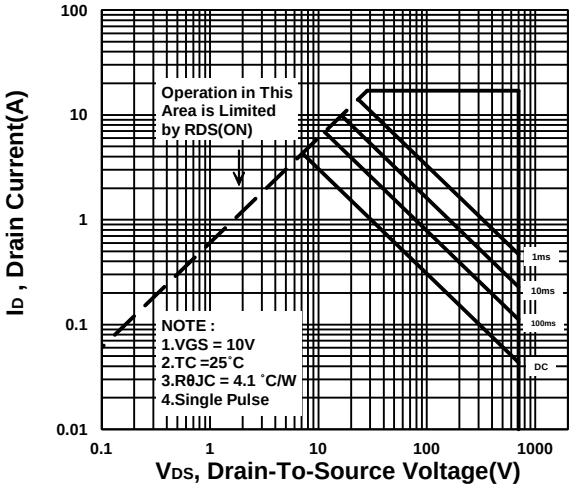
Gate charge Characteristics



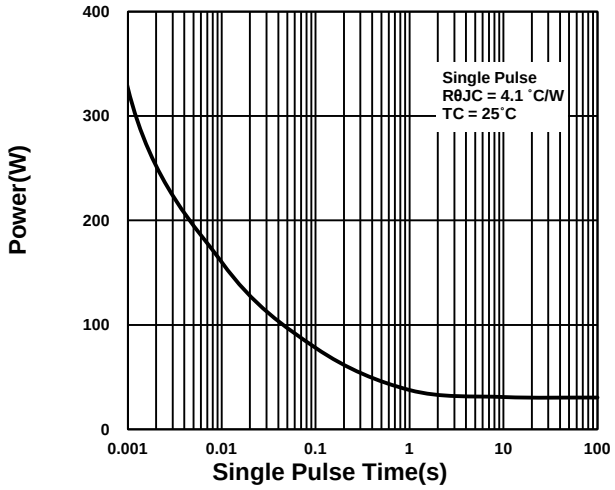
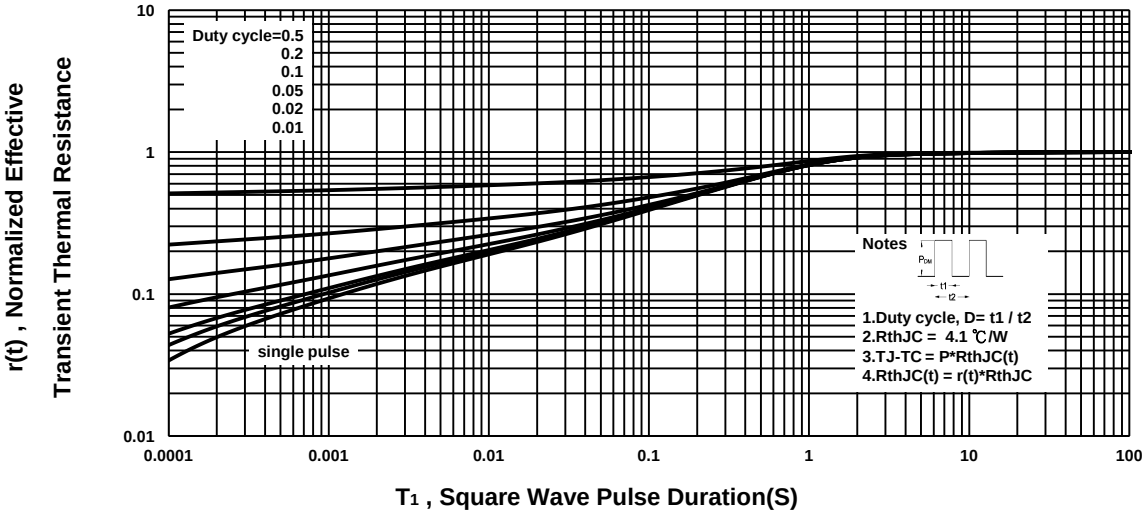
Source-Drain Diode Forward Voltage



Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve